

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	RELEASE BY SECURED PARTY

**CONVEYING PARTY DATA**

Name	Execution Date
Wilmington Trust FSB	09/30/2010

**RECEIVING PARTY DATA**

Name:	ISOLA USA Corp.
Street Address:	3100 West Ray Road, Suite 301
City:	Chandler
State/Country:	ARIZONA
Postal Code:	85226

**PROPERTY NUMBERS Total: 66**

Property Type	Number
Patent Number:	6440567
Patent Number:	6509414
Patent Number:	5512381
Patent Number:	5508328
Patent Number:	4789770
Patent Number:	6168898
Patent Number:	6255039
Patent Number:	6083855
Patent Number:	4665154
Patent Number:	4806596
Patent Number:	5142151
Patent Number:	5387656
Patent Number:	5350621
Patent Number:	5464658
Patent Number:	4767643

**CH \$2640.00 6440567**

Patent Number:	5334696
Patent Number:	4501787
Patent Number:	5160567
Patent Number:	5457319
Patent Number:	5626774
Patent Number:	6242078
Patent Number:	6187852
Patent Number:	6322885
Patent Number:	7507471
Patent Number:	7090924
Application Number:	10310418
Patent Number:	7255927
Patent Number:	6658375
Application Number:	10858344
Application Number:	11002045
Patent Number:	7425371
Patent Number:	7521494
Application Number:	10314602
Application Number:	09928103
Patent Number:	5670250
Patent Number:	5437914
Patent Number:	5779870
Patent Number:	6618238
Patent Number:	5362534
Patent Number:	5557843
Patent Number:	5545466
Patent Number:	6609294
Patent Number:	6584820
Patent Number:	6768316
Patent Number:	6632511
Patent Number:	4853423
Patent Number:	5262491
Patent Number:	5162450
Patent Number:	4975319
Patent Number:	5073605

Patent Number:	5141791
Patent Number:	5108842
Patent Number:	5098781
Patent Number:	5096771
Patent Number:	5213886
Patent Number:	6403229
Patent Number:	5626804
Patent Number:	6436276
Patent Number:	6955740
Patent Number:	7687556
Application Number:	10952102
Application Number:	11269132
Application Number:	07994003
Application Number:	11230318
Application Number:	07958625
Application Number:	08084694

**CORRESPONDENCE DATA**

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Address Line 4: New York, NEW YORK 10036

ATTORNEY DOCKET NUMBER:	244130/1195
NAME OF SUBMITTER:	Elaine D. Ziff

Total Attachments: 8  
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**RELEASE OF SECURITY INTEREST IN PATENTS**

This RELEASE OF SECURITY INTEREST IN PATENTS, dated as of September 30, 2010 (the "Release"), is made by Wilmington Trust FSB, a federal savings banks (as successor in interest to Goldman Sachs Credit Partners, L.P.) located at 50 South Sixth Street, Suite 1290, Minneapolis, Minnesota 55402, in its capacity as Collateral Agent pursuant to that certain Credit Agreement ("Assignor"), in favor of ISOLA USA Corp., a Delaware corporation located at 3100 West Ray Road, Suite 301, Chandler, Arizona 85226 ("Assignee").

All capitalized terms used but not otherwise defined herein have the meanings given to them in the Security Agreement, the Isola Patent Security Agreement and the Polyclad Patent Security Agreement (each as defined below), as applicable.

**WITNESSETH**

WHEREAS, Assignee and Polyclad Laminates, Inc. ("Polyclad") are parties to that certain Security Agreement (Second Lien), dated as of December 18, 2006, (the "Security Agreement") in favor of Goldman Sachs Credit Partners L.P. ("Goldman Sachs") pursuant to which (i) Assignee entered into that certain Patent Security Agreement (Second Lien), dated as of December 18, 2006, as amended (the "Isola Patent Security Agreement") and (ii) Polyclad entered into that certain Patent Security Agreement (Second Lien), dated as of December 18, 2006 (the "Polyclad Patent Security Agreement");

WHEREAS, the Isola Patent Security Agreement was recorded with the United States Patent and Trademark Office on January 9, 2007 at Reel/Frame No. 018746/0030 and the Polyclad Patent Security Agreement was recorded with the United States Patent and Trademark Office on January 9, 2007 at Reel/Frame No. 018746/0040;

WHEREAS, Assignee and Goldman Sachs entered into that certain Amendment No. 1 to Isola Patent Security Agreement, dated as of May 19, 2008 (the "Amendment"), which added certain Patents, listed on Schedule I attached thereto, to the Patent Collateral (as defined therein), and the Amendment was recorded with the United States Patent and Trademark Office on May 23, 2008 at Reel/Frame No. 020995/0149;

WHEREAS, pursuant to the Isola Patent Security Agreement and the Amendment, Assignee pledged and granted to Goldman Sachs for the benefit of the Secured Parties, and pursuant to the Polyclad Patent Security Agreement, Polyclad pledged and granted to Goldman Sachs for the benefit of the Secured Parties a lien on and security interest in and to all of their respective right, title and interest in, to and under all of the following Pledged Collateral of Assignee and Polyclad (the "Patent Collateral"):

- (a) Patents of Assignee listed on Schedule I attached to the Isola Patent Security Agreement;
- (b) Patents of Assignee listed on Schedule I to the Amendment;

- (c) Patents of Polyclad listed on Schedule I to the Polyclad Patent Security Agreement; and
- (d) all Proceeds of any and all of the foregoing (other than Excluded Property);

WHEREAS, pursuant to that certain Agency Assignment and Amendment Agreement, dated as of March 3, 2009, Assignor succeeded Goldman Sachs as Administrative Agent and Collateral Agent for each of the patents listed in Schedule I to the Isola Patent Security Agreement, Schedule I to the Amendment and Schedule I to the Polyclad Patent Security Agreement, and notice of Assignor's succession as Administrative Agent and Collateral Agent was recorded with the United States Patent and Trademark Office on April 17, 2009 at Reel/Frame No. 022562/0670, except for U.S. Patent No. 5,292,557 and U.S. Patent Application Nos. 11/634471 and 11/637222;

WHEREAS, on August 3, 2010, Polyclad merged into Assignee and such merger was recorded with the United States Patent and Trademark Office on August 17, 2010 at Reel/Frame No. 024838/0688; and

WHEREAS, Assignor and Assignee desire that Assignor terminate and release its lien on and security interest in and to the Patent Collateral including, without limitation, the Patents set forth in Schedule A hereto.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged:

Assignor hereby terminates, releases and discharges fully its lien on and security interest in and to all of the Patent Collateral, including but not limited to the Patents listed on Schedule A hereto, and reassigns and transfers any right, title and interest that Assignor may have in the Patent Collateral to Assignee.

Assignor hereby authorizes Assignee or Assignee's authorized representative to (i) record this Release with the United States Patent and Trademark Office, (ii) file UCC financing statement amendments with the applicable filing office in order to memorialize the release of any security interest of Assignor in the Patent Collateral, and/or (iii) otherwise record or file this Release in the applicable governmental office or agency.

Assignor further agrees to execute and deliver to Assignee any and all further documents and instruments, and do any and all further acts which Assignee (or its agents or designees) reasonably request (at Assignee's sole cost and expense) in order to confirm this Release and Assignee's right, title, and interest in or to the Patent Collateral.

[SIGNATURE PAGE FOLLOWS]

IN WITNESS WHEREOF, Assignor has caused this Release to be duly executed and delivered by its duly authorized officer as of the date first written above.

WILMINGTON TRUST FSB, AS ASSIGNOR

By: Timothy P. Mowdy

Name: Timothy P. Mowdy

Title: Vice President

**SCHEDULE A  
TO  
RELEASE OF SECURITY INTEREST  
IN PATENTS**

<b>Company</b>	<b>Jurisdiction</b>	<b>Title</b>	<b>Patent No. (Application Number)</b>	<b>Issue Date (Filing Date)</b>
ISOLA USA Corp.	US	"Halogen free flame retardant adhesive resin coated composite"	6440567	August 27, 2002
ISOLA USA Corp.	US	"Epoxy Resins, Styrene-Maleic Anhydride Copolymer and Co-crosslinking Agent"	6509414	January 21, 2003
ISOLA USA Corp.	US	"Copper Foil Laminate for Protecting Multilayer Articles"	5512381	April 30, 1996
ISOLA USA Corp.	US	"Curing epoxy resins using dicy, imidazole and acid"	5508328	April 16, 1996
ISOLA USA Corp.	US	"Controlled Depth Laser Drilling system"	4789770	December 6, 1988
ISOLA USA Corp.	US	"Positive Acting Photodielectric Composition"	6168898	January 2, 2001
ISOLA USA Corp.	US	"Fabrication of High Density Multilayer Interconnect Printed Circuit Boards"	6255039	July 3, 2001
ISOLA USA Corp.	US	"Methods for Manufacturing Voidless Resin Impregnated Webs"	6083855	July 4, 2000
ISOLA USA Corp.	US	"Homogeneous Thermoset Copolymer from Poly (Vinyl Benzyl Ether) and Dicyanate Ester"	4665154	May 12, 1987
ISOLA USA Corp.	US	"Homogeneous Thermoset Copolymers"	4806596	February 21, 1989
ISOLA USA Corp.	US	"Method for Measuring Degree of a Cure of Resin in a Composite Material and Process for Making the Same"	5142151	August 25, 1992
ISOLA USA Corp.	US	"Substituted Cyanosuanidines as Curing Agents for Epoxy Resins"	5387656	February 7, 1995
ISOLA USA Corp.	US	"A System of Electronic Laminates with Improved Registration Properties"	5350621	September 27, 1994

**EXECUTION VERSION**

<b>Company</b>	<b>Jurisdiction</b>	<b>Title</b>	<b>Patent No. (Application Number)</b>	<b>Issue Date (Filing Date)</b>
ISOLA USA Corp.	US	"A System of Electronic Laminates with Improved Registration Properties"	5464658	November 7, 1995
ISOLA USA Corp.	US	"Method of Continuously Vacuum Impregnating Fibrous Sheet Material"	4767643	August 30, 1988
ISOLA USA Corp.	US	"Polyimide Resin Laminates"	5334696	August 2, 1994
ISOLA USA Corp.	US	"Flame Retardant B-Staged Epoxy Resin Prepregs and Laminates Made Therefrom"	4501787	February 26, 1985
ISOLA USA Corp.	US	"A System and Method for Manufacturing Copper-Clad Glass Epoxy Laminates"	5160567	November 3, 1992
ISOLA USA Corp.	US	"Process for Measurement of the Degree of Cure and Percent Resin of Fiberglass-Reinforced Epoxy Resin Prepreg"	5457319	October 10, 1995
ISOLA USA Corp.	US	"Solder Mask for Manufacture of Printed Circuit Boards"	5626774	May 6, 1997
ISOLA USA Corp.	US	"High Density Printed Circuit Substrate and Method of Fabrication"	6242078	June 5, 2001
ISOLA USA Corp.	US	"Fillers for Improved Epoxy Laminates"	6187852	February 13, 2001
ISOLA USA Corp.	US	"Talc Particles as Fillers for Improved Epoxy Laminates"	6322885	November 27, 2001
ISOLA USA Corp.	US	"Reducing Dusting Of Epoxy Laminates"	7507471	March 24, 2009
ISOLA USA Corp.	US	"Thermosetting Resin Composition for High Performance Laminates"	7090924	August 15, 2006
Isola USA Corp.	US	"Thermosetting Resin Composition for High Performance Laminates:	(10/310418)	(December 4, 2002)
ISOLA USA Corp.	US	"Laminate Composition"	7255927	August 14, 2007

**EXECUTION VERSION**

<b>Company</b>	<b>Jurisdiction</b>	<b>Title</b>	<b>Patent No. (Application Number)</b>	<b>Issue Date (Filing Date)</b>
ISOLA USA Corp.	US	"Compensation Model and Registration Simulator Apparatus and Method for Manufacturing of Printed Circuit Boards"	6658375	December 2, 2003
ISOLA USA Corp.	US	"Laminate Composite For Producing Reduced Curl Flat Thin Core Laminate"	(10/858344)	(June 1, 2004)
ISOLA USA Corp.	US	"Copolymer of Styrene and Maleic Anhydride Comprising an Epoxy Resin Composition and A Co-Cross-Linking Agent"	(11/002045)	(May 4, 2005)
ISOLA USA Corp.	US	"Thermosetting resin composition for high performance laminates"	7425371	September 16, 2008
ISOLA USA Corp.	US	"Epoxy Resin, SMA Copolymer and Bis-maleimide Resin"	7521494	April 21, 2009
ISOLA USA CORP	US	"Copolymer of styrene and maleic anhydride comprising an epoxy resin composition and a co-cross linking agent"	(10/314602)	(December 9, 2002)
ISOLA USA Corp.	US	"Visible and fluorescent dye containing laminate materials"	(09/928103)	(August 10, 2001)
ISOLA USA Corp.	US	"Circuit board prepreg with reduced dielectric constant"	5670250	September 23, 1997
ISOLA USA Corp.	US	"Copper-clad laminate and printed wiring board"	5437914	August 1, 1995
ISOLA USA Corp.	US	"Methods of manufacturing laminates and printed circuit boards"	5779870	July 14, 1998
ISOLA USA Corp.	US	"Parallel plate buried capacitor"	6618238	September 9, 2003
ISOLA USA Corp.	US	"Multiple layer printed circuit boards and method of manufacture"	5362534	November 8, 1994
ISOLA USA Corp.	US	"Method of making a circuit board or layer thereof including semi-curing a second adhesive coated on a cured first adhesive"	5557843	September 24, 1996
Polyclad Laminates, Inc.	US	"Copper-clad Laminate and Printed Wiring Board"	5545466	August 13, 1996

**EXECUTION VERSION**

<b>Company</b>	<b>Jurisdiction</b>	<b>Title</b>	<b>Patent No. (Application Number)</b>	<b>Issue Date (Filing Date)</b>
ISOLA USA Corp.	US	"Method of bulk fabricating printed wiring board laminates"	6609294	August 26, 2003
ISOLA USA Corp.	US	"Surface enhance metal press plates for use in manufacture of laminate and multilayer materials"	6584820	July 1, 2003
ISOLA USA Corp.	US	"Laser cutting of laminates for electrical insulation testing"	6768316	July 27, 2004
ISOLA USA Corp.	US	"Manufacture of prepregs and laminates with relatively low dielectric constant for printed circuit boards"	6632511	October 14, 2003
Polyclad Laminates, Inc.	US	"Curable polyphenylene ether-polyepoxide compositions useful in Printed circuit board production"	4853423	August 1, 1989
ISOLA USA Corp.	US	"High performance curable ppo/monomeric epoxy compositions with tin metal salt compatibilizing agent"	5262491	November 16, 1993
ISOLA USA Corp.	US	"Curable dielectric polyphenylene ether-polyepoxide compositions"	5162450	November 10, 1992
Polyclad Laminates, Inc.	US	"Printed circuit board from fibers impregnated with epoxy resin mixture, halogenated bisphenol and polyphenylene ether"	4975319	December 4, 1990
ISOLA USA Corp.	US	"Polyepoxide and polyphenylene ether-polyepoxide compositions useful in printed circuit board production"	5073605	December 17, 1991
ISOLA USA Corp.	US	Curable polyphenylene ether-polyepoxide compositions from melt processed polyphenylene ethers, and laminates prepared therefrom	5141791	August 25, 1992
ISOLA USA Corp.	US	"Curable dielectric polyphenylene ether-polyepoxide compositions useful in printed circuit board production:	5108842	April 28, 1992

**EXECUTION VERSION**

<b>Company</b>	<b>Jurisdiction</b>	<b>Title</b>	<b>Patent No. (Application Number)</b>	<b>Issue Date (Filing Date)</b>
ISOLA USA Corp.	US	“Thermoplastic film, reinforced hollow glass microsphere reinforced laminates for thin low dielectric constant substrates”	5098781	March 24, 1992
ISOLA USA Corp.	US	Fibers impregnated with epoxy resin mixture, brominated bisphenol and polyphenylene ether	5096771	March 17, 1992
ISOLA USA Corp.	US	Curable dielectric polyphenylene ether-polyepoxide compositions	5213886	May 25, 1993
ISOLA USA Corp.	US	“Cyanate ester based thermoset compositions”	6403229	June 11, 2002
ISOLA USA Corp.	US	“Roller position controller for a continuous belt press”	5626804	May 6, 1997
ISOLA USA Corp.	US	"Cathodic photoresist stripping process"	6436276	August 20, 2002
ISOLA USA Corp.	US	“Production of laminates for printed wiring boards using protective carrier”	6955740	January 10, 2002
ISOLA USA Corp.	US	“Flame retardant compositions”	7687556	March 30, 2010
ISOLA USA Corp.	US	“Low expansion dielectric compositions”	(10/952102)	(September 28, 2004)
ISOLA USA Corp.	US	“Flame retardant compositions with a phosphorated compound”	(11/269132)	(November 8, 2005)
ISOLA USA Corp.	US	“Mixtures of Dicyandiamide and Substituted Dicyandiamides as Curing Agents for Epoxy Resins”	(07/994003)	(December 21, 1992)
ISOLA USA Corp.	US	“Halogen Free Flame Retardant Adhesive Resin Coated Composite”	(11/230318)	(September 19, 2005)
Polyclad Laminates, Inc.	US	“Polyphenylene ether/polyepoxide resin system for electric laminates”	(07/958625)	(October, 9, 1992)
Polyclad Laminates, Inc.	US	“Roller position controller for a continuous belt press”	(08/084694)	(June 29, 1993)
ISOLA USA Corp.	US	“Method of Manufacturing Laminates”	Unknown	December 6, 2005
Polyclad Laminates, Inc.	US	“Halogen free compound with curable polyphenylene ether”	Unfiled	

**PATENT**

**RECORDED: 10/01/2010**

**REEL: 025077 FRAME: 0155**